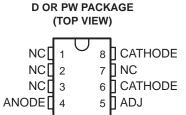
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- Excellent Temperature Stability
- Initial Tolerance . . . 0.2% Max
- Dynamic Impedance . . . 0.6 Ω Max
- Wide Operating Current Range
- Directly Interchangeable With LM136
- Needs No Adjustment for Minimum Temperature Coefficient

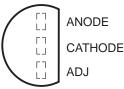
description/ordering information

The LT1009 reference circuit is precision-trimmed 2.5-V shunt regulator featuring low dynamic impedance and a wide operating current range. The maximum initial tolerance is ±5 mV in the LP package and ±10 mV in the D package. The reference tolerance is achieved by on-chip trimming, which minimizes the initial voltage tolerance and the temperature coefficient α_{VZ} .



NC - No internal connection





Although the LT1009 needs no adjustments, a third terminal (ADJ) allows the reference voltage to be adjusted $\pm 5\%$ to eliminate system errors. In many applications, the LT1009 can be used as a terminal-for-terminal replacement for the LM136-2.5, which eliminates the external trim network.

The LT1009 uses include 5-V system references, 8-bit analog-to-digital converter (ADC) and digital-to-analog converter (DAC) references, and power-supply monitors. The device also can be used in applications such as digital voltmeters and current-loop measurement and control systems.

The LT1009C is characterized for operation from 0° C to 70° C. The LT1009I is characterized for operation from -40° C to 85° C.

ORDERING INFORMATION

TA	PACKAG	BE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	COIC (D)	Tube of 75	LT1009CD	40000
	SOIC (D)	Reel of 2500	LT1009CDR	1009C
		Bulk of 1000	LT1009CLP	
0°C to 70°C	TO-226 / TO-92 (LP)	Ammo of 2000	LT1009CLPM	LT1009C
		Reel of 2000	LT1009CLPR	
	T000D (DW)	Tube of 150	LT1009CPW	40000
	TSSOP (PW)	Reel of 2000	LT1009CPWR	1009C
-40°C to 85°C	0010 (D)	Tube of 75	LT1009ID	40001
	SOIC (D)	Reel of 2500	LT1009IDR	10091
	TO-226 / TO-92 (LP)	Bulk of 1000	LT1009ILP	LT1009I
	10-226 / 10-92 (LP)	Reel of 2000	LT1009ILPR	L110091
	T000D (D)40	Tube of 150	LT1009IPW	40001
	TSSOP (PW)	Reel of 2000	LT1009IPWR	10091

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

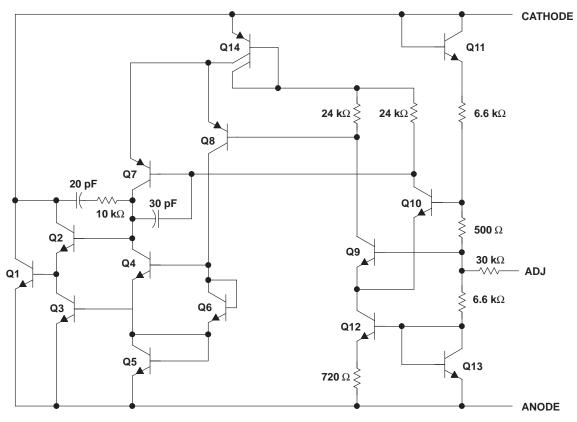


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symbol



schematic



All component values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Reverse current, I _R		20 mA
Forward current, I _F		10 mA
Package thermal impedance, θ _{JA} , (see Notes 1 and 2): D package	97°C/W
	LP package	140°C/W
	PW package	149°C/W
Operating virtual junction temperature, T _J		150°C
Storage temperature range, T _{stg}		. −65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. Maximum power dissipation is a function of $T_{J(max)}$, θ_{JA} , and T_{A} . The maximum allowable power dissipation at any allowable ambient temperature is $P_{D} = (T_{J(max)} T_{A})/\theta_{JA}$. Operation at the absolute maximum T_{J} of 150°C can impact reliability.
 - 2. The package thermal impedance is calculated in accordance with JESD 51-7.



LT1009 2.5-V INTEGRATED REFERENCE CIRCUIT

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recommended operating conditions

			MIN	MAX	UNIT
TA	Operating free-air temperature range	LT1009C	0	70	•°C
		LT1009I	-40	85	

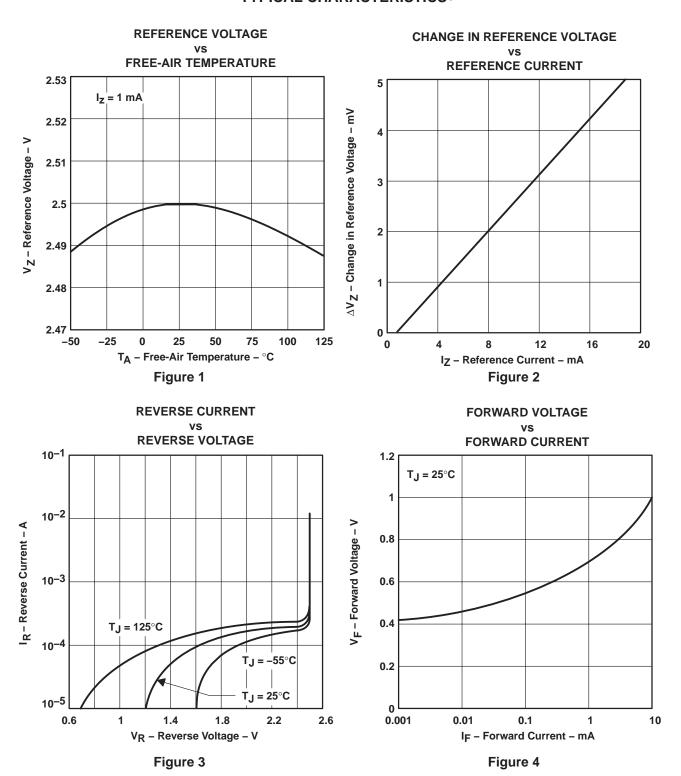
electrical characteristics at specified free-air temperature

PARAMETER		TEST CONDITIONS		T _A †	LT1009C		LT1009I				
					MIN	TYP	MAX	MIN	TYP	MAX	UNIT
			D package	25°C	2.49	2.5	2.51	2.49	2.5	2.51	· v
V _Z Reference volt			LP package		2.495	2.5	2.505	2.495	2.5	2.505	
	Reference voltage	$I_Z = 1 \text{ mA}$	D package		2.485		2.515	2.475		2.525	
			LP package		2.491		2.509	2.48		2.52	
٧F	Forward voltage	$I_F = 2 \text{ mA}$		25°C	0.4		1	0.4		1	V
Adjustment range	$I_Z = 1 \text{ mA},$ $V_{ADJ} = GNI$	O to V _Z	2512				125				
	$I_Z = 1 \text{ mA},$ $V_{ADJ} = 0.6 \text{ N}$	V to V _Z – 0.6 V	25°C	45			45			mV	
ΔVZ(temp) refere	Change in		D package	Full range			5			15	mV
	reference voltage with temperature		LP package				4			15	
Average temperature				0°C to 70°C		15	25			30	nn=/°C
αVZ coefficient of reference voltage	coefficient of reference voltage‡			-40°C to 85°C					20		ppm/°C
Change in ΔV _Z reference voltage with current	•			25°C		2.6	10		2.6	6	
	$I_Z = 400 \mu A \text{ to } 10 \text{ mA}$		Full range			12			10	mV	
ΔV _Z /Δt	Long-term change in reference voltage	I _Z = 1 mA		25°C		20			20		ppm/khr
	Reference	nce		25°C		0.3	1		0.3	1	0
^Z Z impedance		I _Z = 1 mA		Full range			1.4			1.4	Ω

 $^{^{\}dagger}$ Full range is 0°C to 70°C for the LT1009C and –40°C to 85°C for the LT1009I.

[‡] The average temperature coefficient of reference voltage is defined as the total change in reference voltage divided by the specified temperature range.

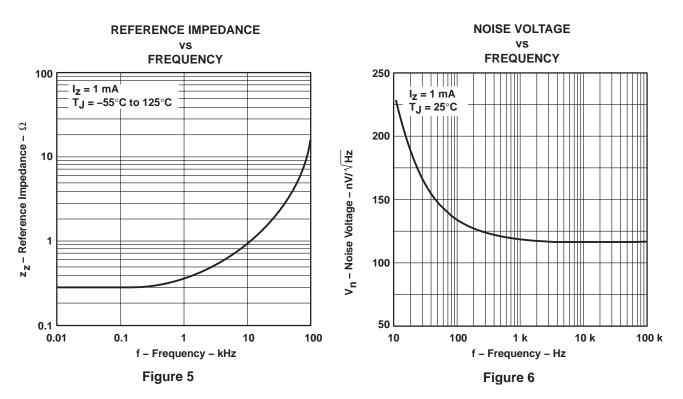
TYPICAL CHARACTERISTICS[†]



[†]Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



TYPICAL CHARACTERISTICS



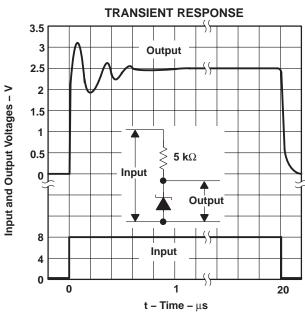
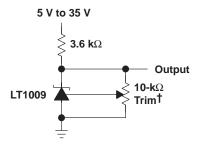


Figure 7

APPLICATION INFORMATION



†This does not affect temperature coefficient. It provides $\pm 5\%$ trim range.

Figure 8. 2.5-V Reference

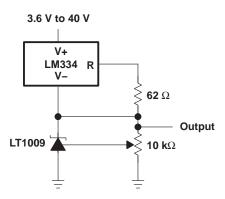


Figure 9. Adjustable Reference With Wide Supply Range

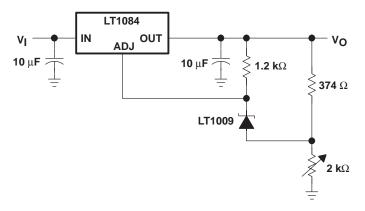


Figure 10. Power Regulator With Low Temperature Coefficient



APPLICATION INFORMATION

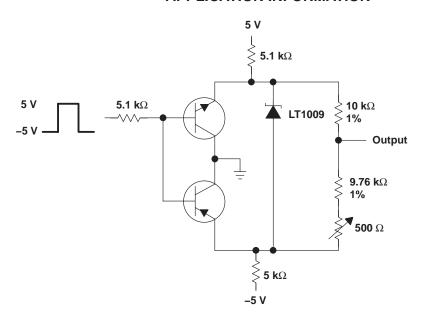


Figure 11. Switchable ±1.25-V Bipolar Reference

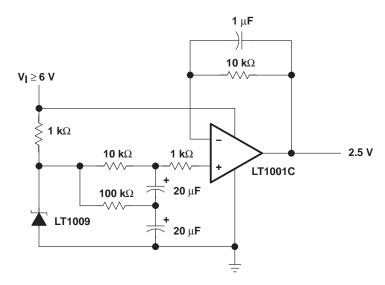
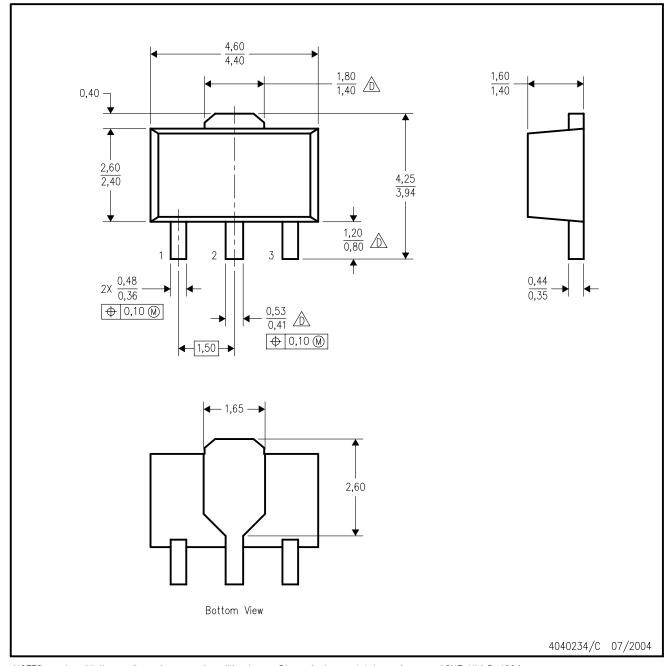


Figure 12. Low-Noise 2.5-V Buffered Reference

PK (R-PSSO-F3)

PLASTIC SINGLE-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5—1994.

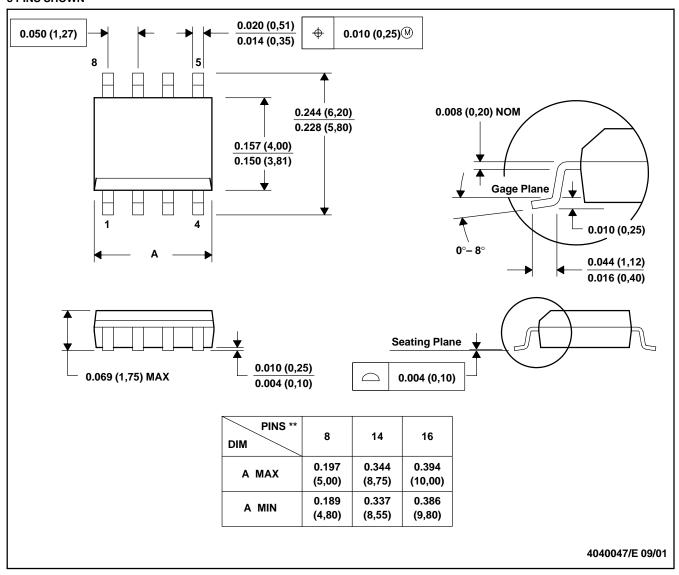
- B. This drawing is subject to change without notice.
- C. The center lead is in electrical contact with the tab.
- Falls within JEDEC TO-243 variation AA, except minimum lead length, pin 2 minimum lead width, and minimum tab width.



D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice. $\hfill \hfill \$

C.\ Lead dimensions are not controlled within this area

D. FAlls within JEDEC TO -226 Variation AA (TO-226 replaces TO-92)

E. Shipping Method:

Straight lead option available in bulk pack only.

Formed lead option available in tape & reel or ammo pack.



LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Tape and Reel information for the Format Lead Option package.

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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